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	_	Application Number	09/648,777						
TRANSMITTAL FORM (to be used for all correspondence after initial filing)		Filing Date	28 August 2000						
		First Named Inventor	SHI, Song-Hua						
		Group Art Unit	1762						
		Examiner Name	Talbot, B.						
Total Number of Pages in This Submission 4		Attorney Docket Number	GTRC55						
ENCLOSURES (check all that apply)									
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Applicant: SHI. Song-Hua, et al. Group Art Unit: 1762 Serial No.: 09/648,777 Examiner: Talbot, B. Filing Date: 28 August 2000 Docket No.: GTRC55

Title: PROCESS AND MATERIAL FOR LOW-COST FLIP-CHIP SOLDER INTERCONNECT STRUCTURES

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	SHI, Song-Hua, et al.)	Group Art Unit:	1	762	·	
Serial	No.: 09/648,777)	Examiner:	T	'albot, B.		
Filed:	28 August 2000)	FAX RECEIVED				
CC	PROCESS AND MATERIAL FOR LOW- COST FLIP-CHIP SOLDER INTERCONNECT STRUCTURES))) JAN 0 8 2003			}	
)	GROUP 1700				

RESPONSE TO RESTRICTION REQUIREMENT

BOX NON-FEE AMENDMENT

Honorable Commissioner for Patents

Washington, D.C. 20231

Atlanta, GA 30308-2216

7 January 2003

Sir:

The Office Action, Paper No. 6, from Examiner Brian K. Talbot of Art Unit 1762, dated 12 December 2002, has been received and carefully reviewed. In response thereto, Applicant restricts the Application to Claims 1-28 (Group I), drawn to WLCFU, classified in Class 438, Subclass 1+.

CONCLUSION

Registration No. 45,083

By the present Response To Restriction Requirement, Claims 1-28 are pending in the Application for examination purposes. Should the Examiner have any further questions or reservations, the Examiner is invited to telephone the undersigned Attorney at 404.885.2773

I hereby certify that this correspondence is being three to The Eraniner, Group art Unit 1762 of the USPTO

Name of Applicant Assistant, o

Registered Represents

5% January 2003

TROUTMAN SANDERS LLP Bank of America Plaza, Suite 5200 600 Peachtree Street, N.E. Atlanta GA 30308-2216

Tel: 404.885.2773 Fax: 404.962.6849